From: noreply.businessservices@nxp.com
Sent: Monday, November 04, 2013 7:00 AM

To: DigiKey SupplierInfo

Subject: NXP Quality - 201310011F01 - Final Product Change Notification

Attachments: NXP_FPCN_201310011F01_Diqi_Key_Products+SalesHistory_20131104_140007.xlsx;

NXP_FPCN_201310011F01_Digi_Key_Products_20131104_140004.xlsx



Final Product Change Notification

Issue Date: 05-Nov-2013 **Effective Date:** 03-Feb-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

201310011F01



Management Summary

The display driver PCF8576CT/1 will be assembled with copper (Cu) bond wires instead of gold (Au).

Change Category

[] Wafer Fab process	[X] Assembly Process	[] Product Marking	[] Design
[] Wafer Fab materials	[X] Assembly Materials	[] Electrical spec./Test coverage	[] Mechanical Specification
[] Wafer Fab location	[] Assembly Location	[] Test Location	[] Packing/Shipping/Labeling

PCF8576CT/1 will be assembled with copper (Cu) bond wires instead of gold (Au)

Details of this Change

The display driver PCF8576CT/1 will be assembled with copper (Cu) bond wires instead of gold (Au). The currently available version with gold wire will be discontinued.

There will be two replacement types: PCF8576CT/1 as it is now for non-automotive applications and PCA8576CT/Q900/1 for automotive applications, qualified according to the AEC-Q100 standard.

For software-technical reasons we can only show the non-automotive part in the attached parts lists. The automotive type has the ordering nr (12 nc) as follows:

Tube: 9353 016 73512 Tape&Reel: 9353 016 73518

Why do we Implement this Change

- To align with world technology trends
- To use wiring with enhanced mechanical and electrical properties

1

Identification of Affected Products

Replacement part type created, see Parts Affected list

- The marking for the non-automotive PCF8576CT/1 will not change. The marking for the PCA8576CT/Q900 will change on the first line to: "PCA8576CT/Q".
- The new products will be shipped in a dry pack.

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 03-Feb-2014

Impact

no impact to the product's functionality anticipated. Moisture sensitivity level will change from 1 to 3.

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 05-Dec-2013.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Cengiz Oezcan
Position Quality Mgr. PL CWG
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Customer Focus, Passion to Win.

NXP Quality Management Team.

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